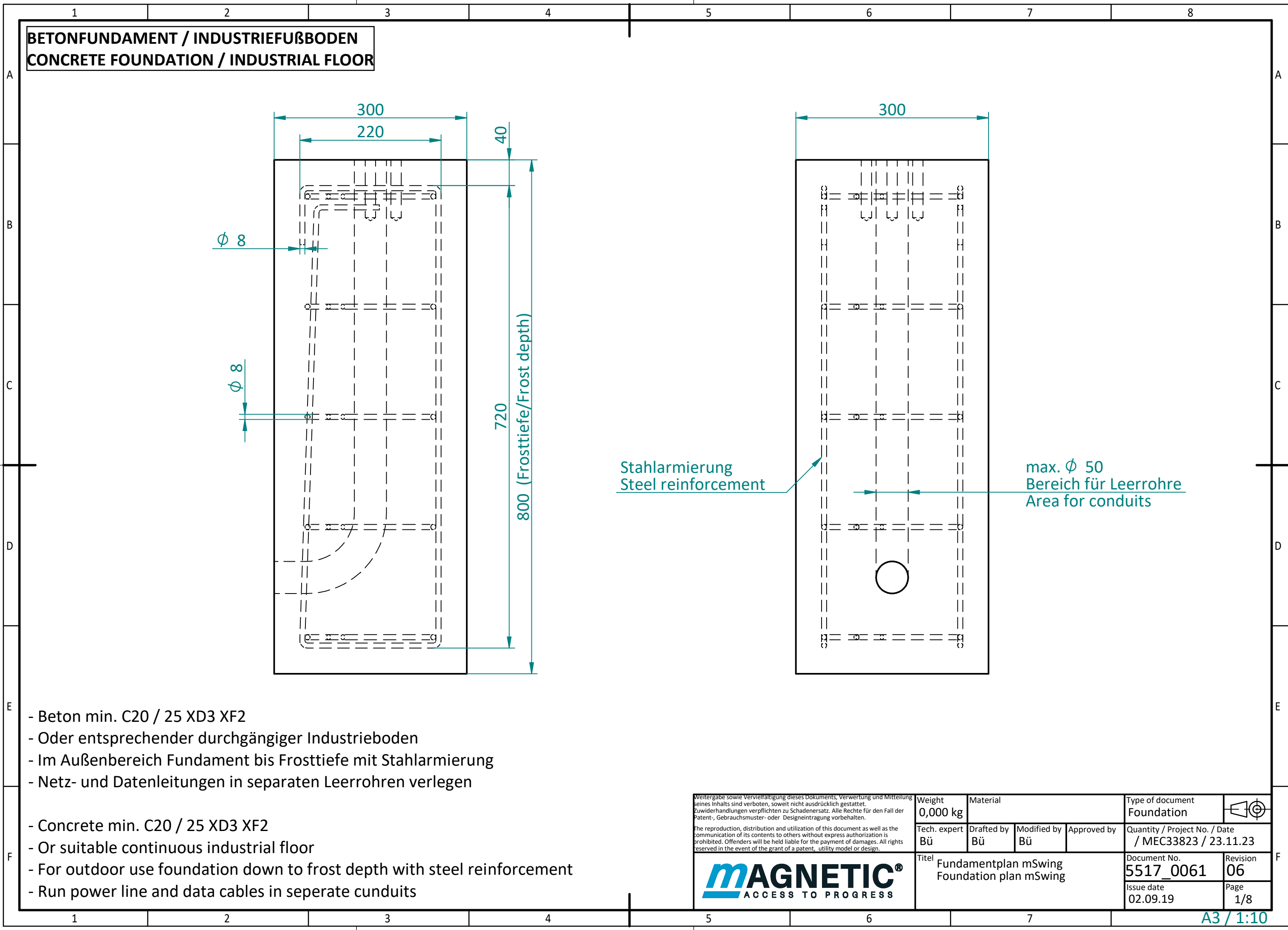
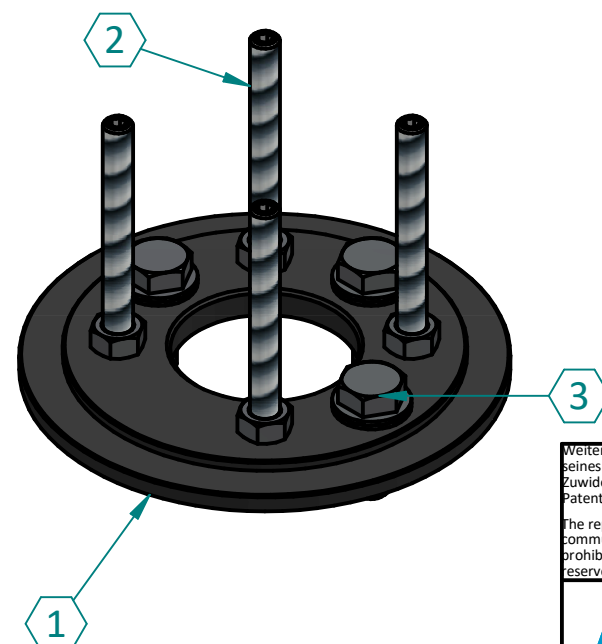
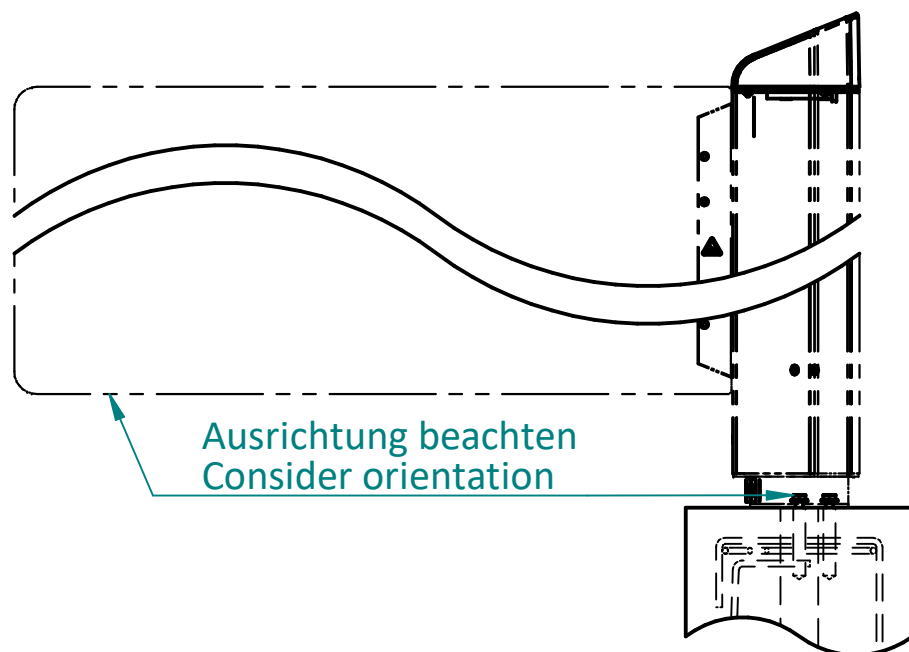
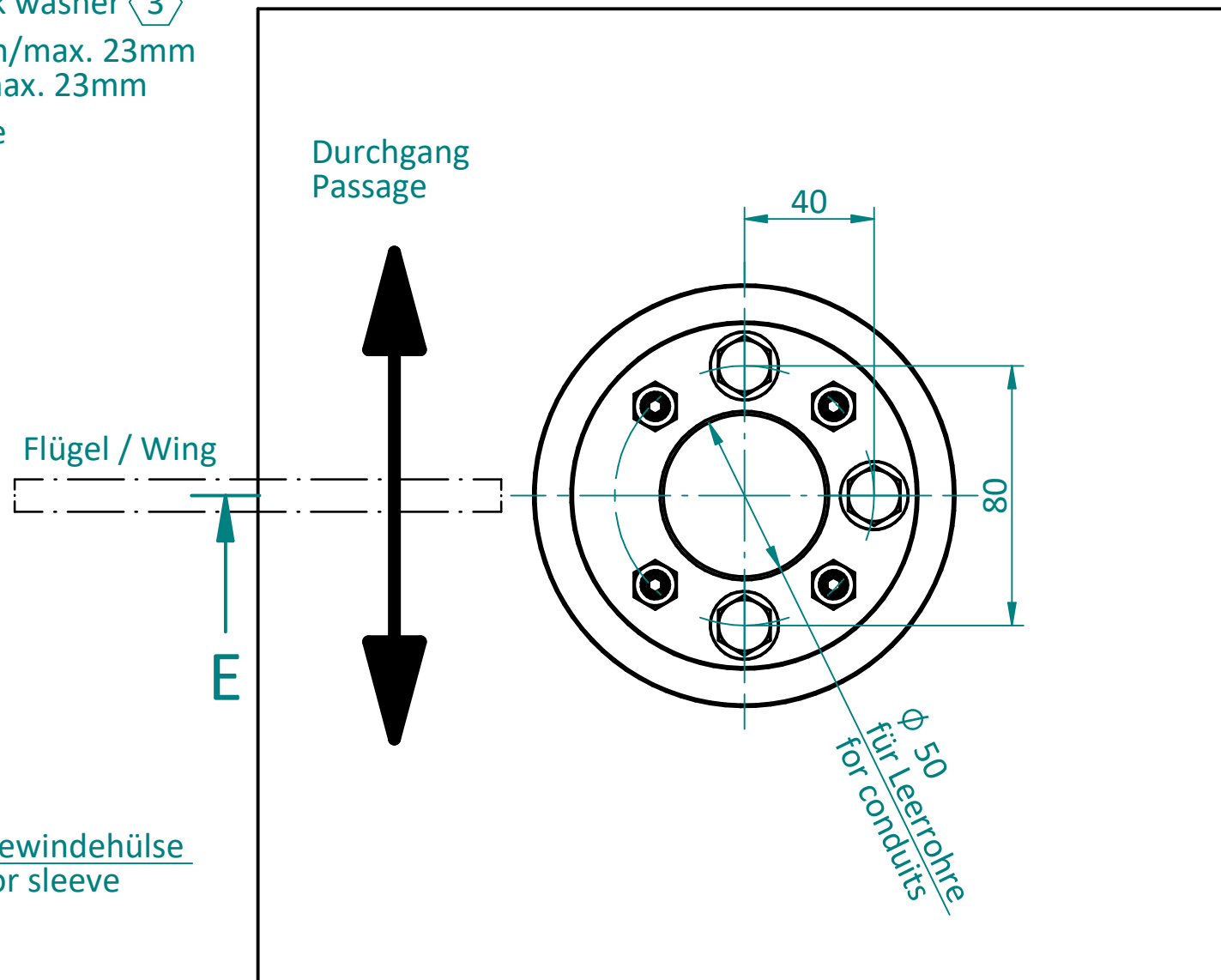
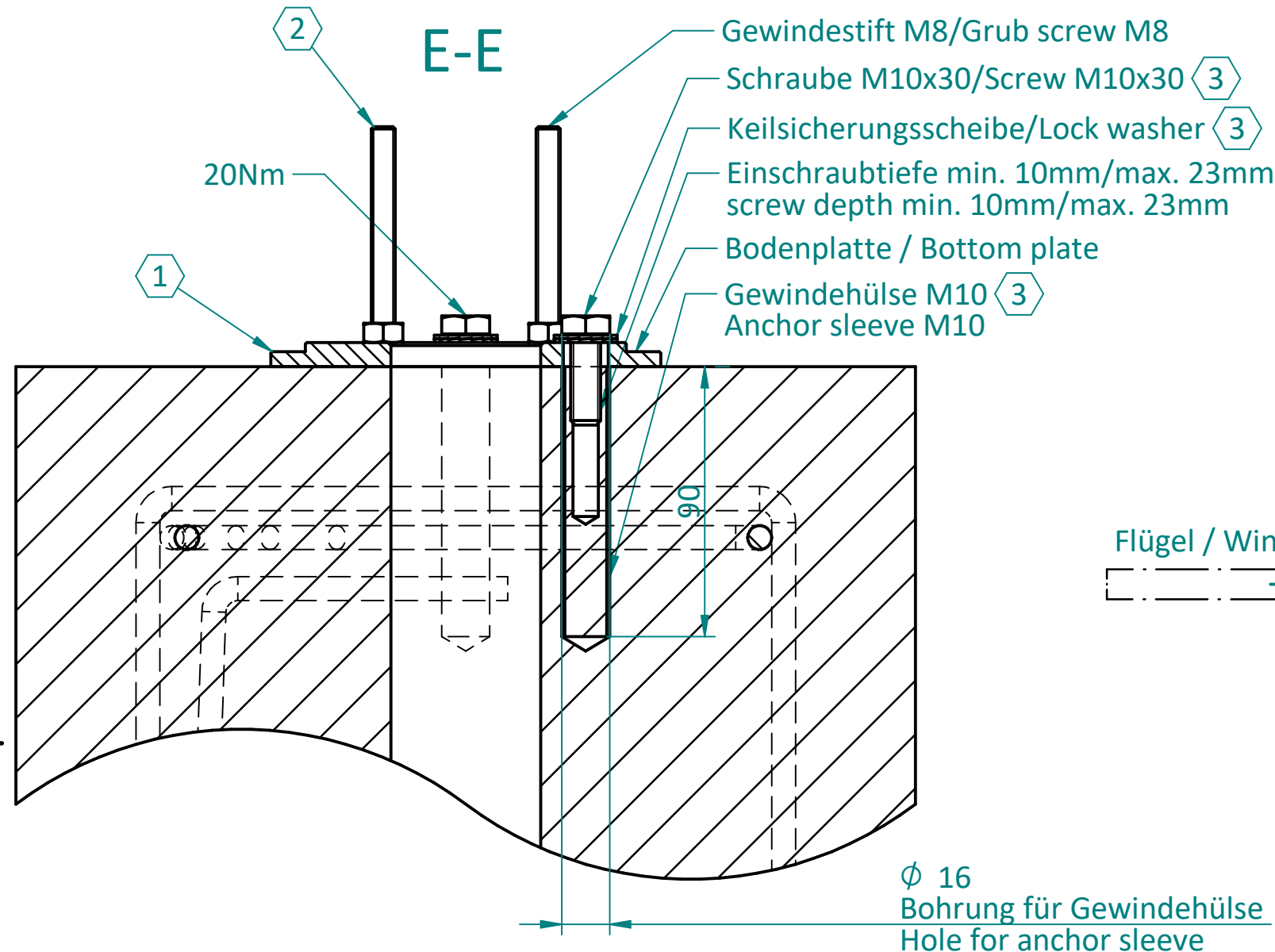




# BODENBEFESTIGUNG / BOTTOM FIXING

A  
B  
C  
D  
E  
F



- 1 Bodenplatte als Schablone zum Bohren verwenden
- 1 Use bottom plate as template for drilling holes
- 2 Bodenplatte mithilfe der Gewindestifte eben ausrichten
- 2 Level the bottom plate with the grub screws
- 3 Aus/From BSS103

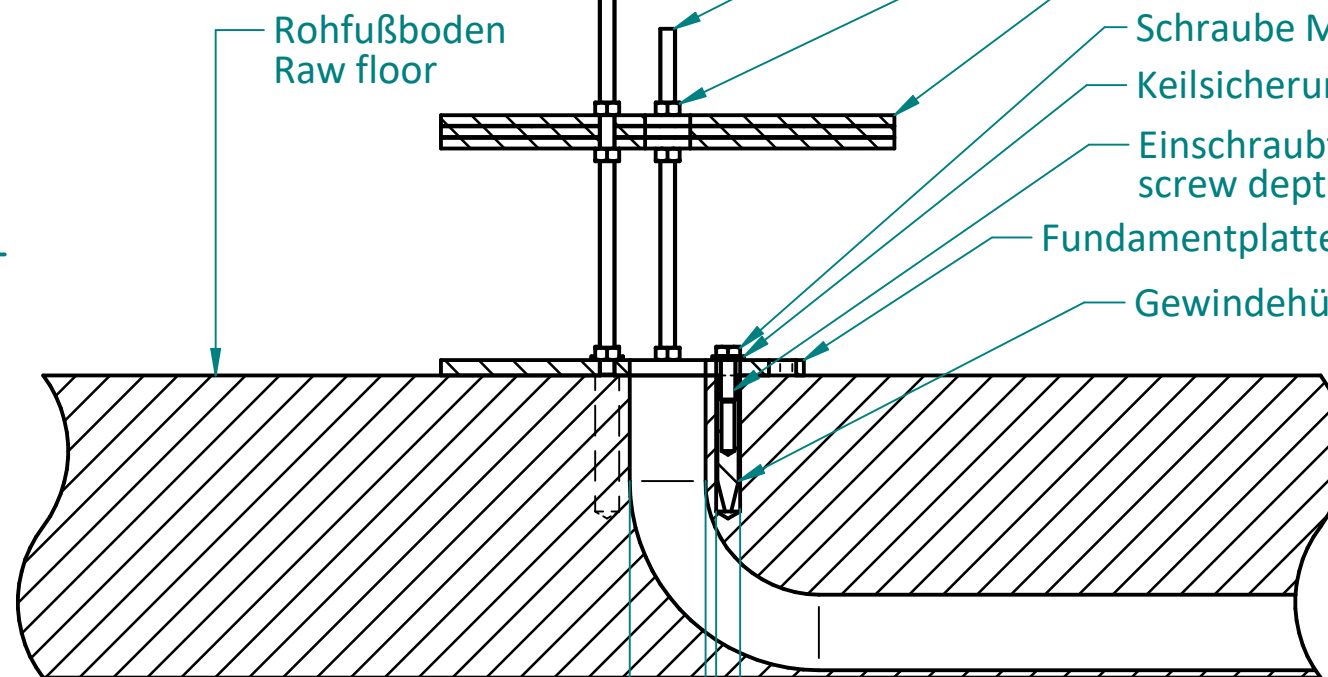
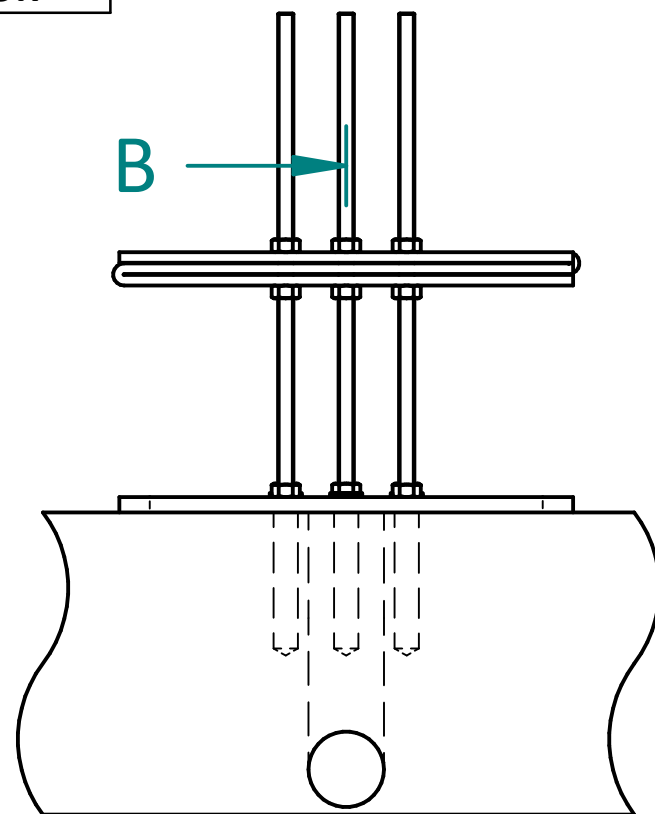
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|                                                         |                  |                   |             | Issue date<br>02.09.19                                 | Page<br>2/8    |

ROH FUßBODEN  
RAW FLOOR



Gewindestange M10 / Threaded rod M10 (4)

Mutter M10 / Hexagon nut M10 (4)

Justierhilfe / Adjusting equipment (4)

Schraube M10x30/Screw M10x30 (3)

Keilsicherungsscheibe/Lock washer (3)

Einschraubtiefe min. 10mm/max. 23mm  
screw depth min. 10mm/max. 23mm

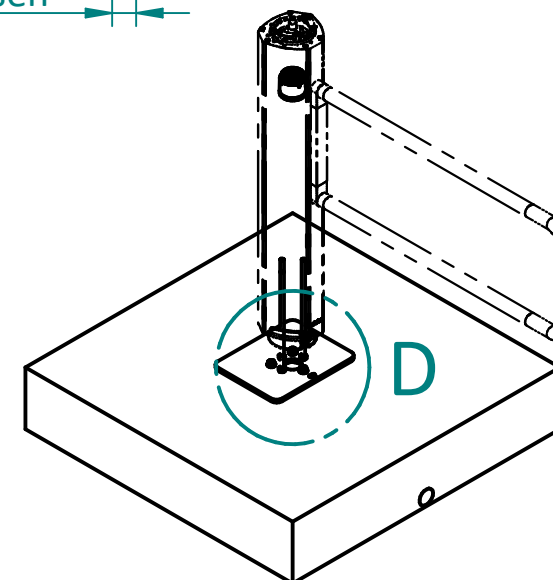
Fundamentplatte / Foundation plate (5)

Gewindehülse M10/Anchor sleeve M10 (3)

- (3) Aus/From BSS103  
(4) Aus/From BSSFURA103  
(5) Aus/From FURA103

Max. 50  
Bereich für Leerrohre  
Area for conduits

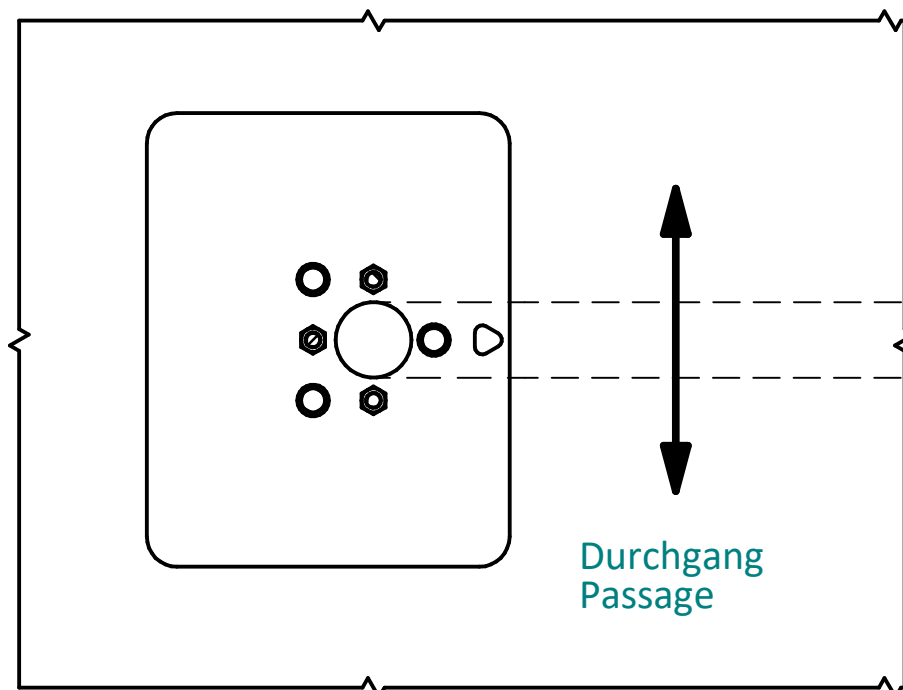
3x  $\phi$  16  
Bohrungen für Gewindehülsen  
Holes for anchor sleeves



20Nm

Ausrichtung beachten  
Consider orientation

C-C  
90°

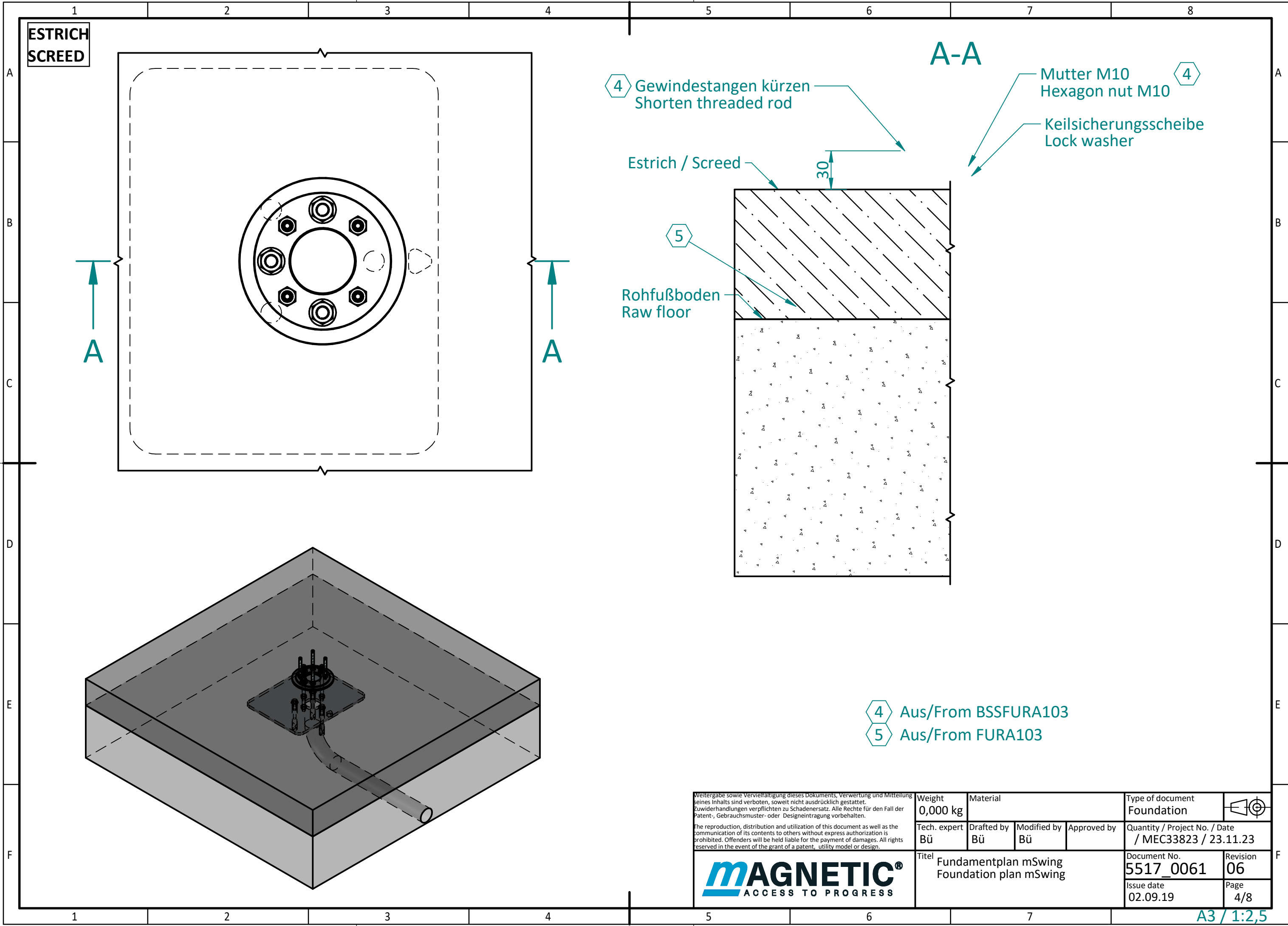


Durchgang  
Passage

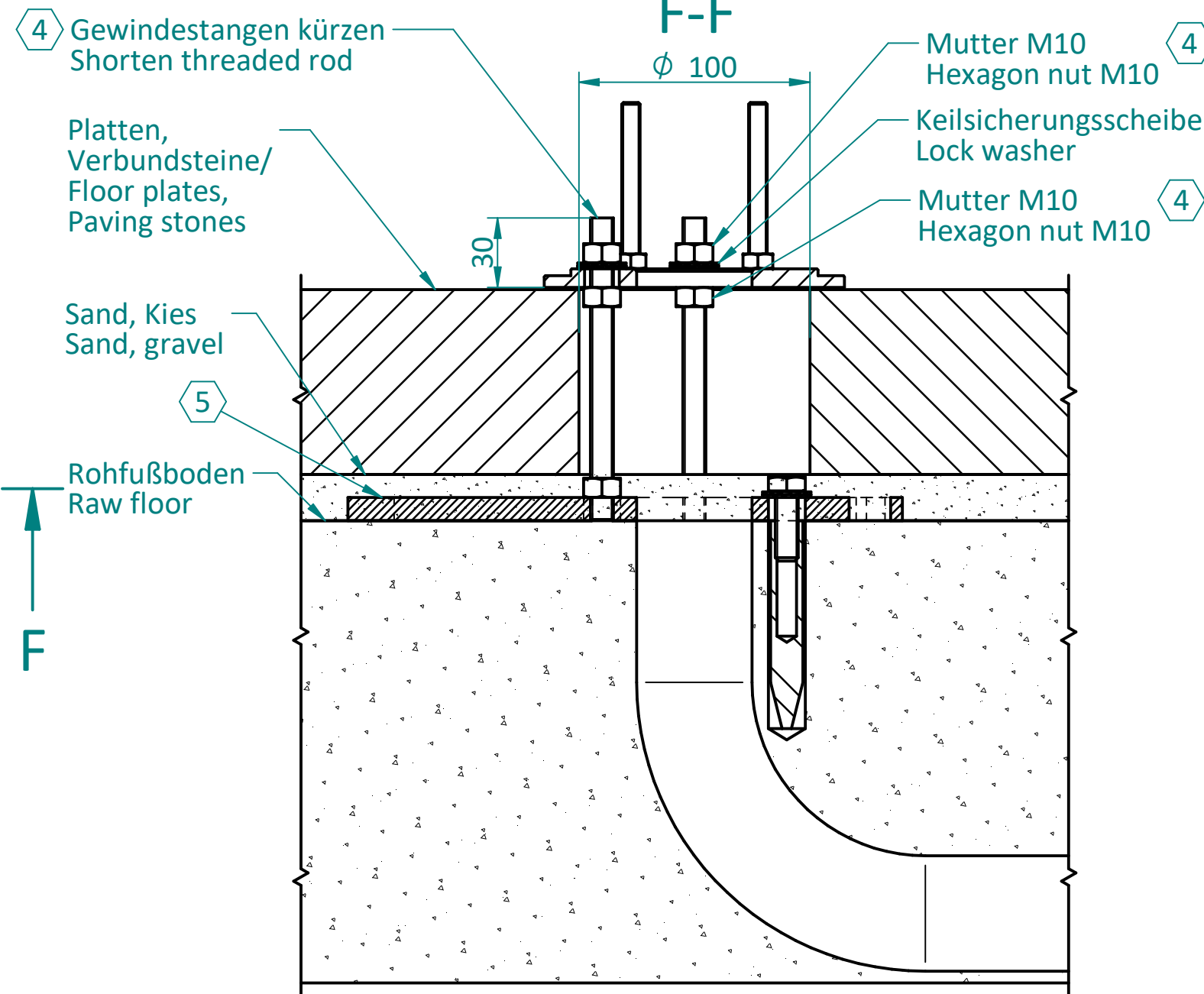
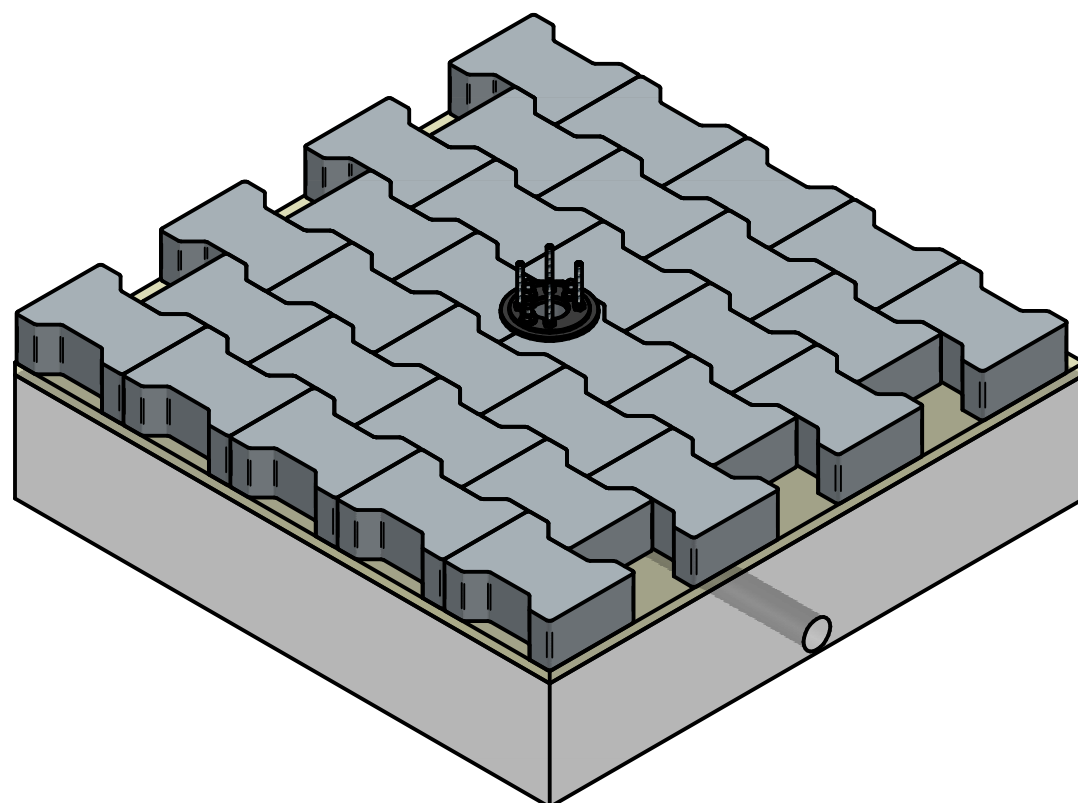
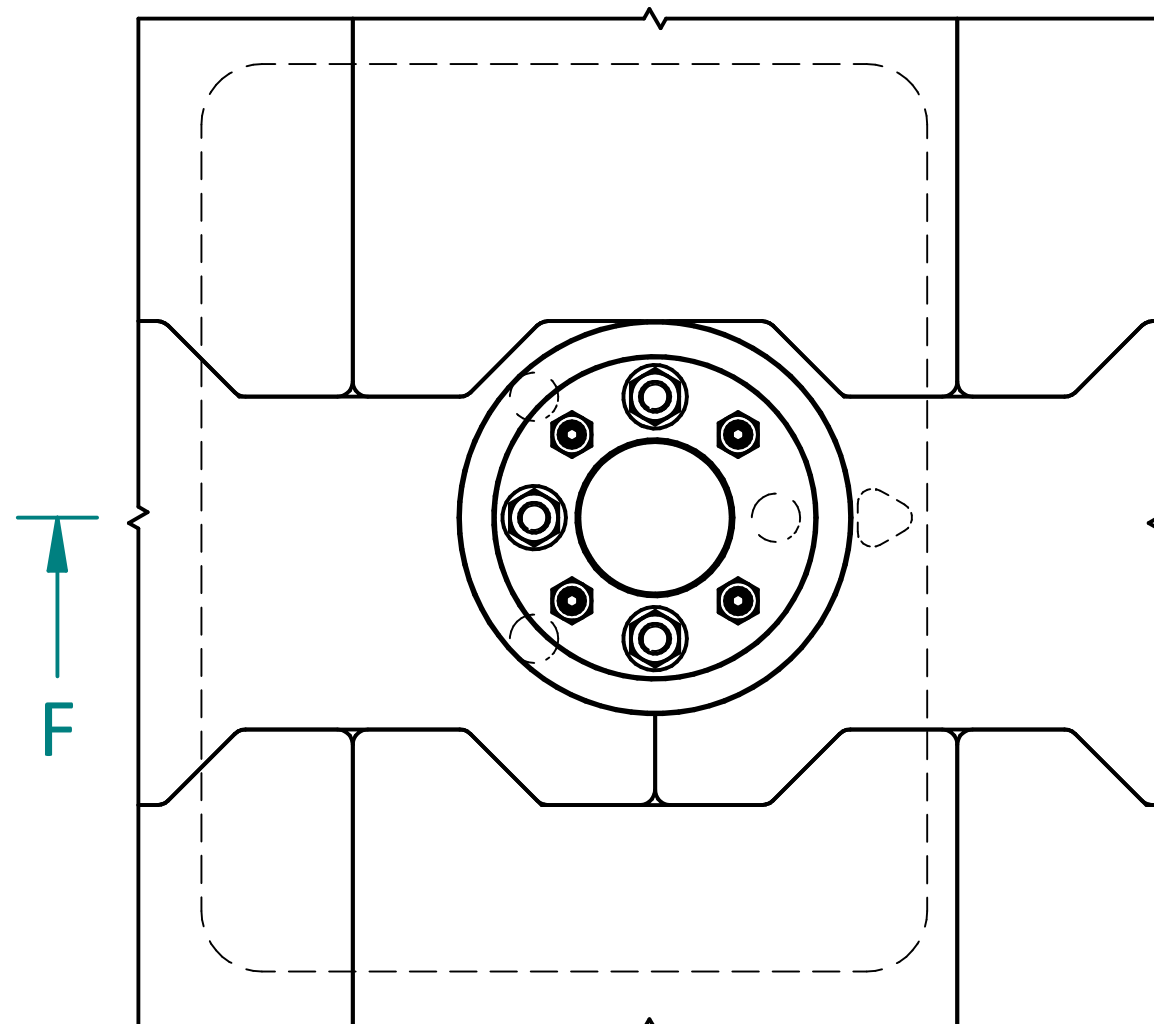
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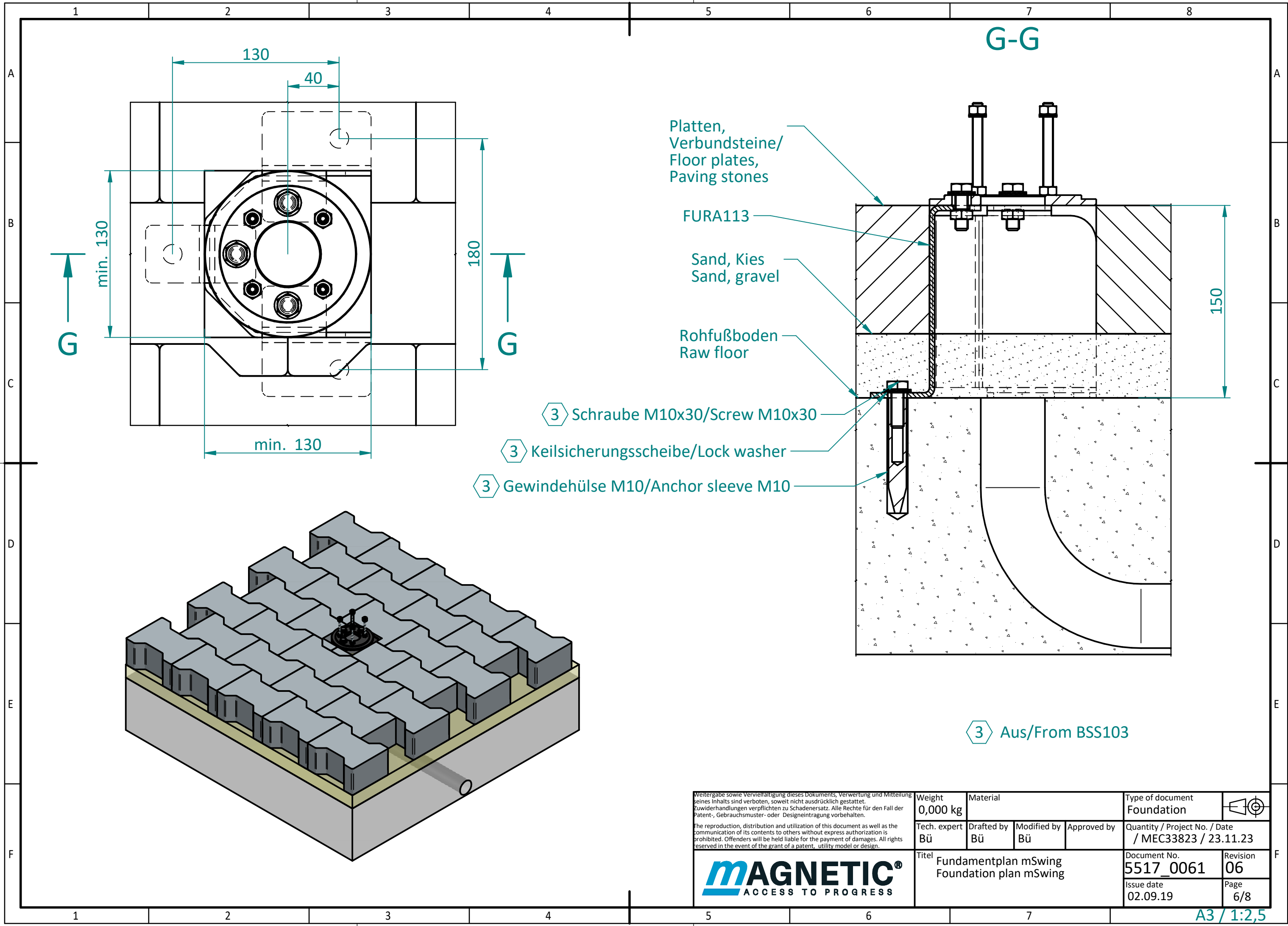


PLATTEN / VERBUNDSTEINE  
FLOOR PLATES / PAVING STONES



4 Aus/From BSSFURA103  
5 Aus/From FURA103

|                                                                                                                                                                                                                                                                                                                   |  |  |  |                                                         |                  |                   |                                                        |                           |
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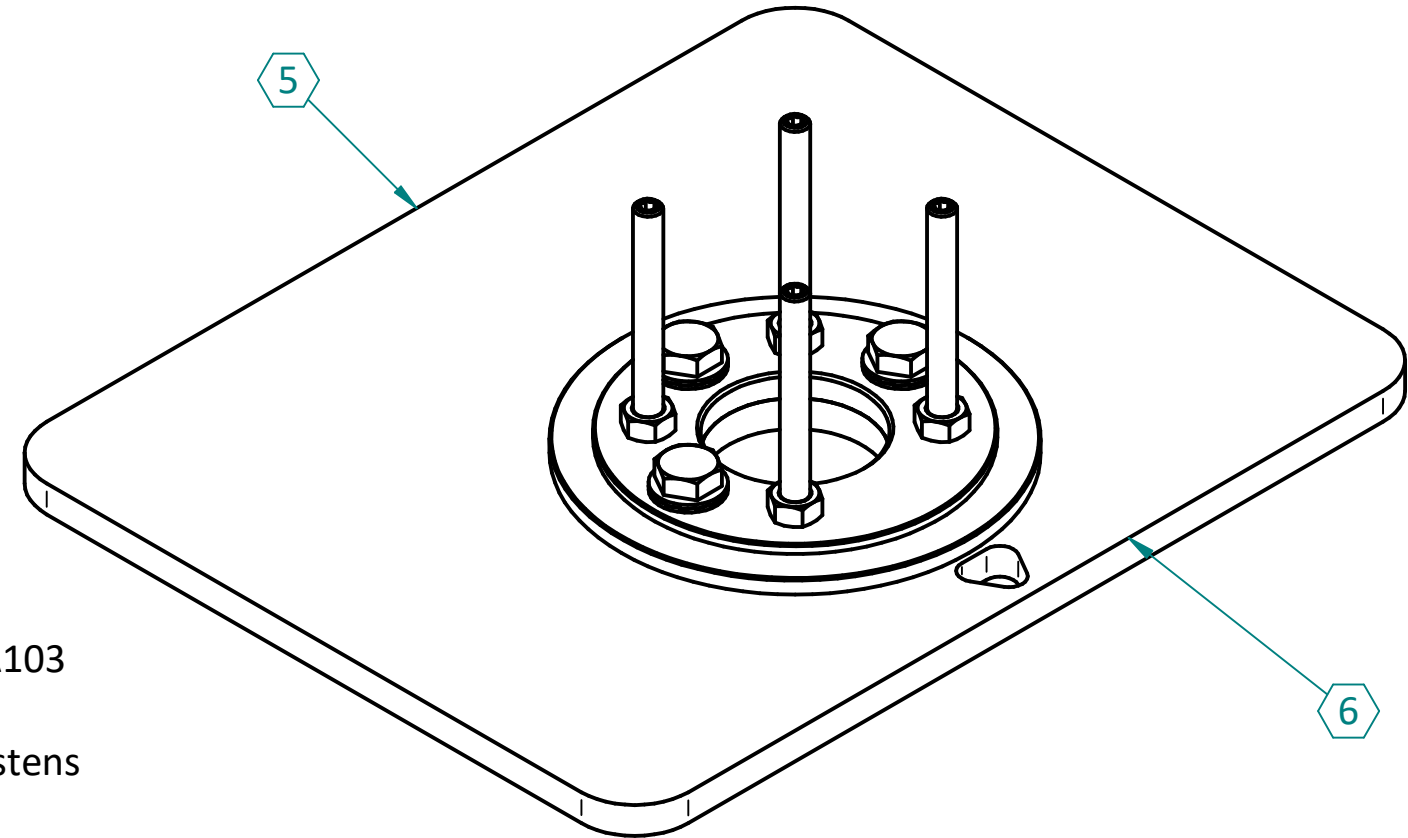


# KLEBEPLATTE GLUING PLATE

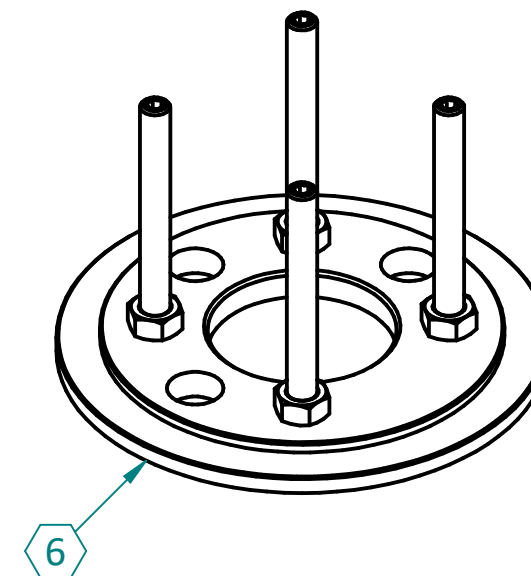
- 4 Aus/From BSSFURA103
- 5 Aus/From FURA103
- 6 Geklebt mit BSSKL100 / Glued with BSSKL100

- Die Bodenplatte kann entweder direkt oder mit der Fundamentplatte FURA103 auf den Boden geklebt werden.
  - Der Boden, auf dem die Klebung erfolgt muss eine Zugfestigkeit von mindestens 2N/mm² haben.
  - Eine Klebung auf lackierten Böden, PVC-Belag, Teppich, Laminaten oder Parkett ist nicht möglich.
  - Von Klebungen auf Fliesen oder Steinplatten ist abzuraten.
  - Die zu verklebenden Flächen des Bodens und der Bodenplatten der Schwenktüre müssen fett-, lack- und farbfrei sein.
  - Für die Klebung müssen die Reiniger und Klebstoffe des Klebesatzes BSSKL100 verwendet werden.
  - Die Hinweise auf den Reinigern und Klebstoffen sind zu beachten.
- 
- The bottom plate can either be glued directly to the floor or together with the foundation plate FURA103.
  - The floor on which the bonding will be done needs to have a tensile strength of at least 2N/mm².
  - A gluing on painted floors, PVC floors, carpet, laminate or parquet floor is not possible.
  - We advise against gluing on tiles or stone plates.
  - The bonding surfaces of the floor and the bottom plates of the swing door need to be free of grease, lacquer and paint.
  - For the gluing the cleaners and adhesives of the gluing set BSSKL100 have to be used.
  - Consider the instructions on the used cleaners and glues.

FURA



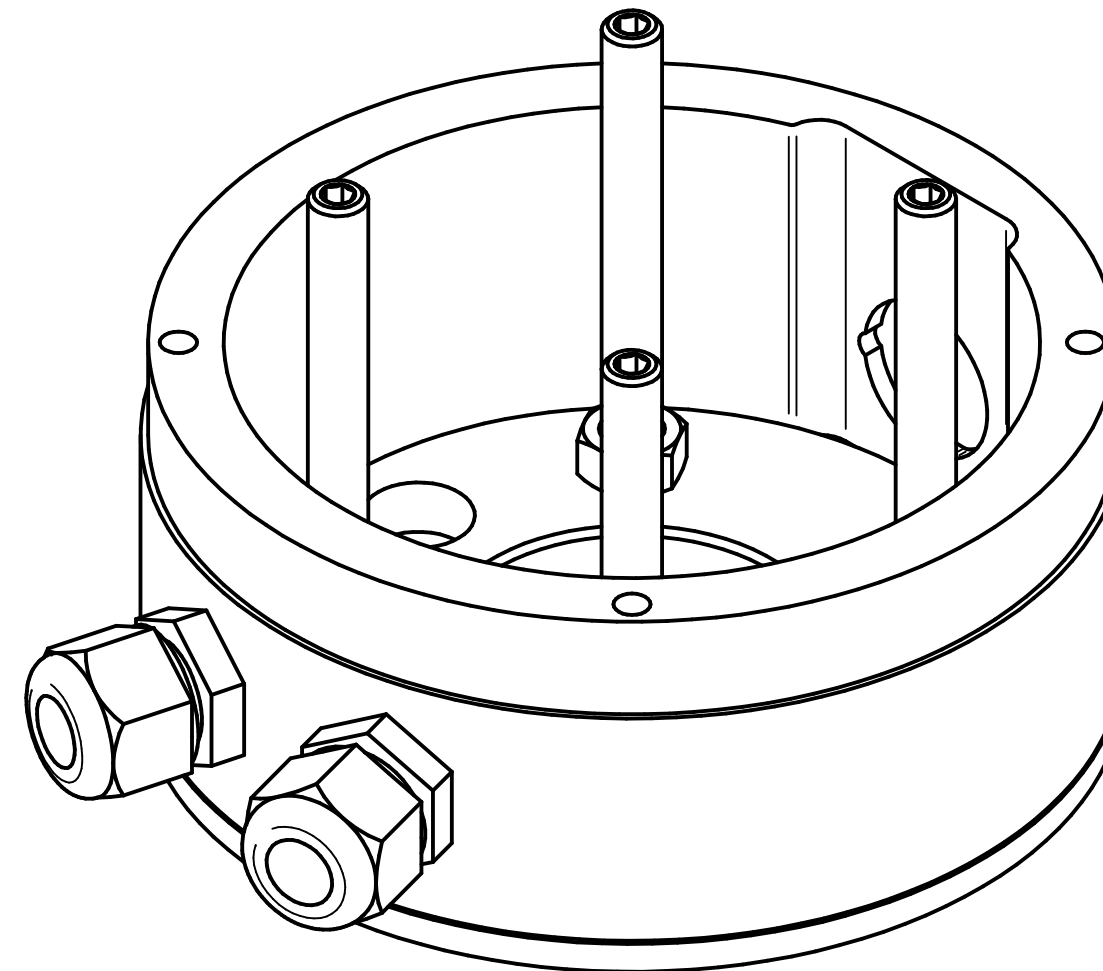
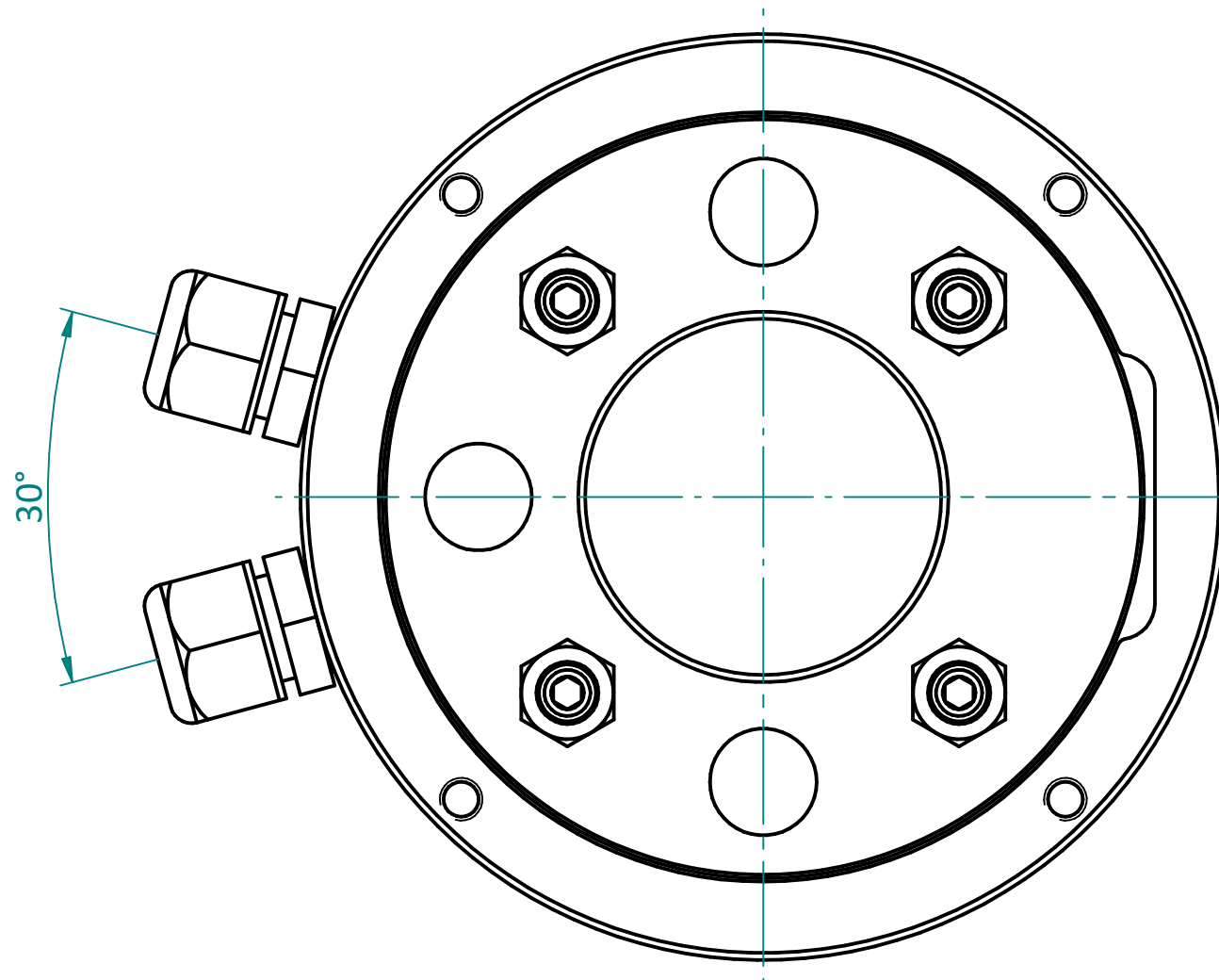
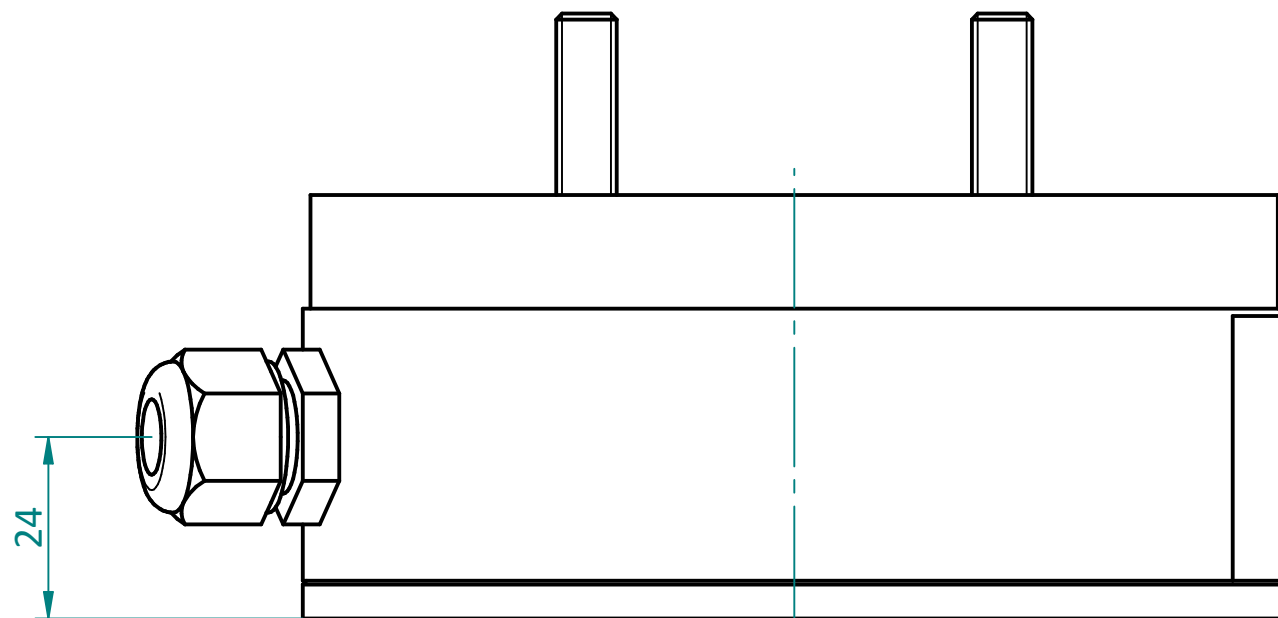
DIRECT



|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |                                                         |                  |                   |             |                                                        |                                                                                       |
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KABEL SEITLICH  
CABLES SIDEWARD



- Falls im Fundament keine Leerrohre verlegt werden können, ist es möglich, in den Bodenring Bohrungen für Kabelverschraubungen einzubringen.
- Leitungen für Netzanschluss und Datenleitungen müssen getrennt verlegt werden.
- If it is not possible to install empty conduits in the foundation some holes for cable glands can be drilled into the bottom ring.
- Wires for power supply and data cables need to be ran separately.

|                                                                                                                                                                                                                                                                                                                                  |  |  |  |                                                         |                  |                   |                                                        |                                             |
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|                                                                                                                                                                                                                                                                                                                                  |  |  |  |                                                         |                  |                   | Page<br>8/8                                            |                                             |